EVALUATION KIT AVAILABLE

MAXIM

Low-Jitter, 8kHz Reference Clock Synthesizer Outputs 35.328MHz

MAX9476

General Description

The MAX9476 low-cost, high-performance clock synthesizer with an 8kHz input reference clock provides six buffered LVTTL clock outputs at 35.328MHz. The clock synthesizer can be used to generate the clocks for systems using T1, E1, T3, E3, and xDSL.

The MAX9476 features a phase-lock loop (PLL) that uses a voltage-controlled crystal oscillator (VCXO). The internal PLL phase locks the external crystal (35.328MHz) to the 8kHz input reference clock. In addition, this device generates a jitter-suppressed output that provides a better source for the reference clock relay.

The MAX9476 is available in a 24-pin TSSOP package and operates over the extended operating temperature range of -40°C to +85°C and a single +3V to +3.6V power-supply range. For using lower value external crystals, refer to the MAX9486 data sheet.

Applications

Telecom Equipment Using T1, E1, T3, E3, and ISDN Protocols

xDSL Equipment in CO with Interface to the Telecom Protocols

Features

♦ **8kHz Input-Reference CLK**

♦ **4ps$_{RMS}$ (typ) Output Jitter**

♦ **High-Jitter Rejection on the Reference CLK**

♦ **Synthesizer Locks to the 8kHz Reference with a ±100ppm Range**

♦ **Output Frequency: 35.328MHz**

♦ **Six Buffered LVTTL Low-Jitter Outputs**

♦ **One 8kHz Reference CLK Relay Output**

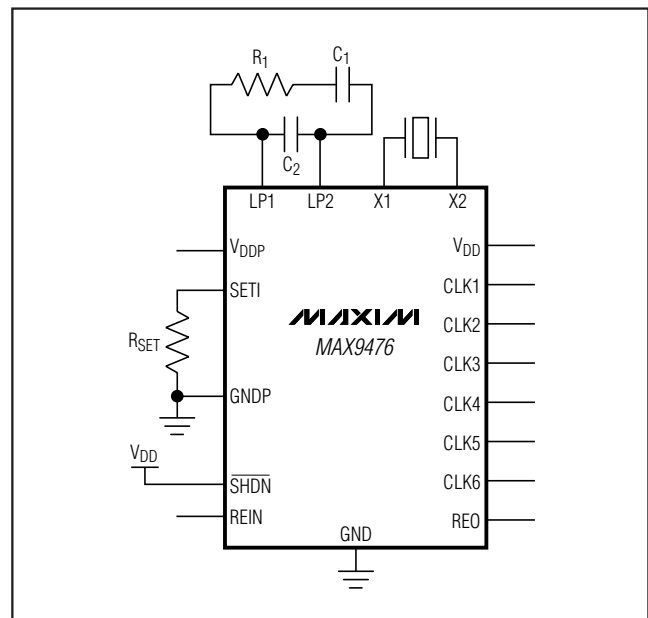♦ **+3.3V Supply Operation**

♦ **24-Pin TSSOP Package**

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE	PKG CODE
MAX9476EUG	-40°C to +85°C	24 TSSOP	U24-1

Pin Configuration

TOP VIEW

TSSOP
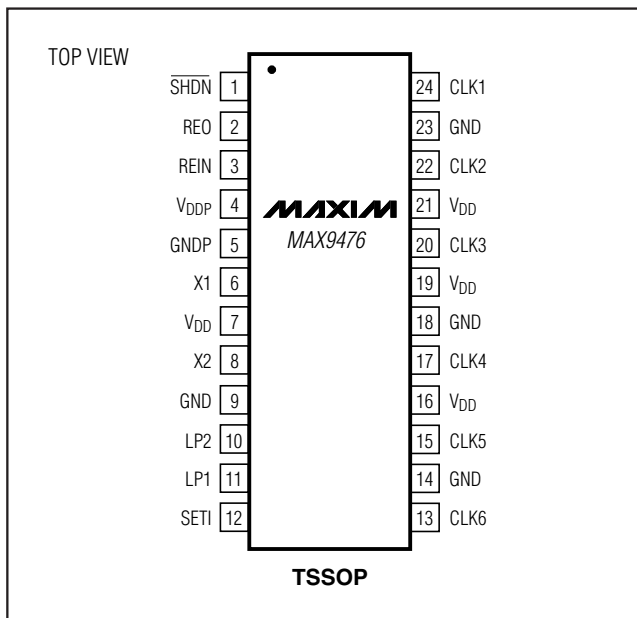
Typical Application Circuit

MAXIM _____ **Maxim Integrated Products   1**

For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

Low-Jitter, 8kHz Reference Clock Synthesizer Outputs 35.328MHz

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ABSOLUTE MAXIMUM RATINGS

V_{DD} to GND .... -0.3V to +4.0V
V_{DDP} to GNDP .... -0.3V to +4.0V
$\overline{SHDN}$, REO, REIN, X1, X2, CLK_ to GND ... -0.3V to (V_{DD} + 0.3V)
LP1, SETI to GNDP .... -0.3V to (V_{DD} + 0.3V)
LP2 Internally Connected to GNDP
Short-Circuit Duration of Outputs .... Continuous

Continuous Power Dissipation (T_A = +70°C)
   24-Pin TSSOP (derate 12.2mW/°C above +70°C) 976mW
Operating Temperature Range .... -40°C to +85°C
Maximum Junction Temperature .... +150°C
Storage Temperature Range .... -60°C to +150°C
ESD Rating (Human Body Model) .... ±2kV
Lead Temperature (soldering, 10s) .... +300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

(V_{DD} = V_{DDP} = +3.0V to +3.6V, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at V_{DD} = V_{DDP} = +3.3V, T_A = +25°C.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
DIGITAL INPUTS (REIN, $\overline{SHDN}$)						
Input-High Logic Level	V_{IH}		2.0			V
Input-Low Logic Level	V_{IL}				0.8	V
Input-Current High Level	I_{IH}	V_{IN} = V_{DD}			20	µA
Input-Current Low Level	I_{IL}	V_{IN} = 0	-20			µA
DIGITAL OUTPUT CLOCKS (CLK1–CLK6, REO)						
Output-High Logic Level	V_{OH}	I_{OH} = -4mA	V_{DD} - 0.6V			V
Output-Low Logic Level	V_{OL}	I_{OL} = 4mA			0.4	V
POWER SUPPLY (V_{DD}, V_{DDP})						
Power-Supply Range	V_{DD}		3.0		3.6	V
PLL Power-Supply Range	V_{DDP}		3.0		3.6	V
Power-Supply Current	I_{DD} + I_{DDP}	(Note 2)		9	16	mA
Shutdown Supply Current	$I_{\overline{SHDN}}$			7.5	30	µA

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AC ELECTRICAL CHARACTERISTICS

(V_{DD} = V_{DDP} = +3.0V to +3.6V, C_L = 20pF, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at V_{DD} = V_{DDP} = +3.3V, T_A = +25°C.) (Note 3)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
DIGITAL OUTPUT CLOCKS (CLK1–CLK6)						
Frequency Range	f_{OUT}			35.328		MHz
Clock Rise Time	t_{R1}	20% to 80% V_{DD}		1.8		ns
Clock Fall Time	t_{F1}	80% to 20% V_{DD}		1.8		ns
Duty Cycle			40	50	60	%
Period Jitter	J_{P1}	Peak-to-peak		83		ps
	J_{P2}	RMS		4		ps_{RMS}
Output Skew	t_S	Peak-to-peak		185		ps
REFERENCE CLOCK OUTPUT (REO)						
Frequency	f_{REF}			8		kHz
Clock Rise Time	t_{R2}			1.8		ns
Clock Fall Time	t_{F2}			1.8		ns
Duty Cycle			40	50	60	%
VCXO						
Crystal Frequency	f_{XTL}			35.328		MHz
Crystal Accuracy		Including frequency accuracy and temperature range		±25		ppm
VCXO Pulling Range		(Note 4)	-100		+100	ppm
Input Reference CLK Pulse Width	t_W	Measured at high or low states	10			ns

Note 1: Specifications are 100% tested at T_A = +25°C. Specifications over temperature are guaranteed by design and characterization.
Note 2: No load on clock outputs.
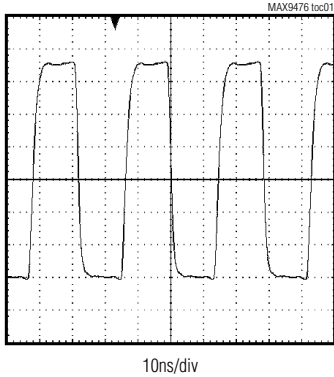**Note 3:** Guaranteed by design.
Note 4: Crystal loading capacitance is 14pF.

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Low-Jitter, 8kHz Reference
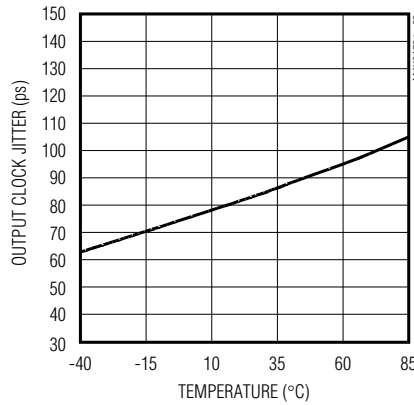# Clock Synthesizer Outputs 35.328MHz

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(V$_{DD}$ = V$_{DDP}$ = +3.3V, T$_A$ = +25°C, unless otherwise noted.)

OUTPUT WAVEFORM

MAX9476 toc01

10ns/div

**OUTPUT CLOCK JITTER (P-P)
vs. TEMPERATURE**

MAX9476 toc02

**OUTPUT CLOCK JITTER (RMS)
vs. TEMPERATURE**

MAX9476 toc03
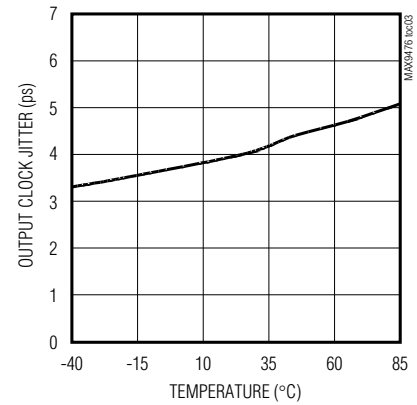
**OUTPUT CLOCK JITTER (P-P)
vs. SUPPLY VOLTAGE**

MAX9476 toc04
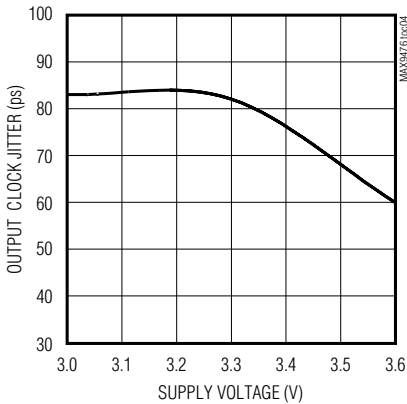
**OUTPUT CLOCK JITTER (RMS)
vs. SUPPLY VOLTAGE**

MAX9476 toc05
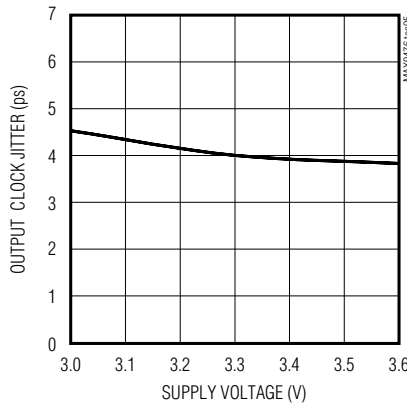
**OUTPUT FREQUENCY VARIATION
vs. INPUT REFERENCE FREQUENCY**

MAX9476 toc06

CENTERED AT
35.328MHz
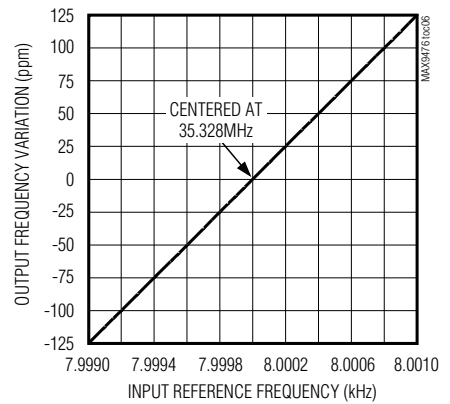
**SUPPLY CURRENT (I$_{DD}$ + I$_{DDP}$)
vs. SUPPLY VOLTAGE**

MAX9476 toc07

T$_A$ = +85°C

T$_A$ = +25°C

T$_A$ = -40°C
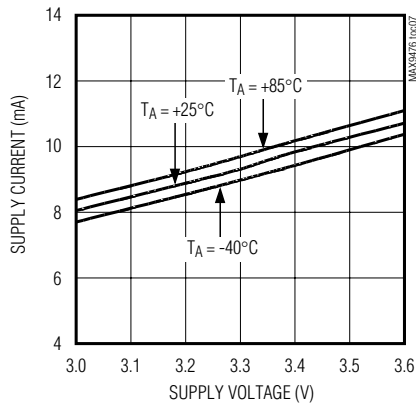
**SHUTDOWN SUPPLY CURRENT
vs. SUPPLY VOLTAGE**
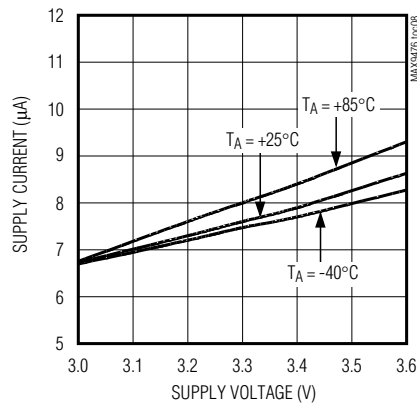
MAX9476 toc08

T$_A$ = +85°C

T$_A$ = +25°C

T$_A$ = -40°C

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Pin Description

PIN	NAME	FUNCTION
1	$\overline{\text{SHDN}}$	Active-Low Shutdown Input
2	REO	Reference Clock Output. REO is an 8kHz reference clock output with jitter suppression.
3	REIN	Reference Input
4	V_{DDP}	Phase-Lock Loop (PLL) Power Supply. Bypass V_{DDP} with 0.1µF and 0.001µF capacitors to GNDP.
5	GNDP	PLL Ground
6	X1	Crystal Input 1. Connect X1 to a fundamental mode crystal for the VCXO.
7, 16, 19, 21	V_{DD}	Digital Power Supply. Bypass V_{DD} with 0.1µF and 0.001µF capacitors to GND.
8	X2	Crystal Input 2. Connect X2 to a fundamental mode crystal for the VCXO.
9, 14, 18, 23	GND	Ground
10	LP2	External Filter 2. Connect the loop filter capacitors and a resistor between LP1 and LP2 (see the *Typical Application Circuit*). LP2 is internally connected to GNDP.
11	LP1	External Filter 1. Connect the loop filter capacitors and a resistor between LP1 and LP2 (see the *Typical Application Circuit*).
12	SETI	Charge-Pump Current-Setting Input. Connect a resistor from SETI to GNDP to set PLL charge-pump current (see the *Detailed Description* section).
13	CLK6	Clock Output 6 at 35.328MHz
15	CLK5	Clock Output 5 at 35.328MHz
17	CLK4	Clock Output 4 at 35.328MHz
20	CLK3	Clock Output 3 at 35.328MHz
22	CLK2	Clock Output 2 at 35.328MHz
24	CLK1	Clock Output 1 at 35.328MHz

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Functional Diagram
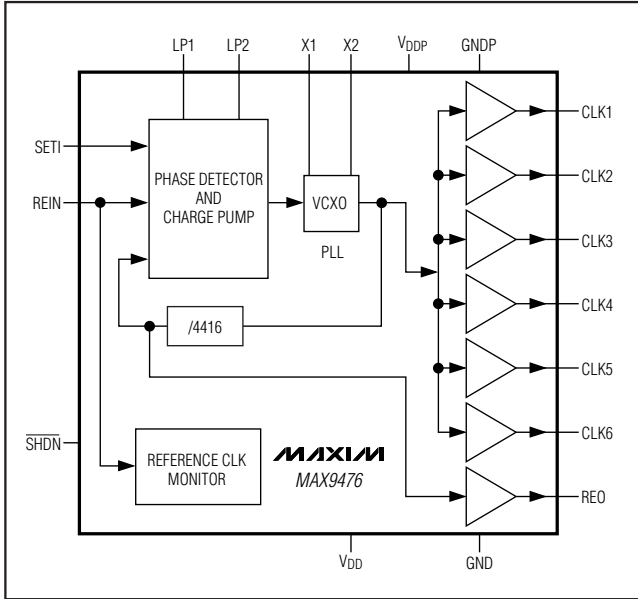
Detailed Description

The MAX9476 is a high-performance clock synthesizer with an 8kHz input reference clock. This device generates six identical buffered LVTTL clock outputs at 35.328MHz. The internal PLL phase locks the external crystal (35.328MHz) to the 8kHz input reference clock. This device features a low-jitter output that provides a better source for the reference clock relay (see the *Functional Diagram*).

Power-Up

At power-up, all the outputs are disabled and pulled low (to GND) for at least 256ms. After 256ms, the crystal oscillator starts oscillation. If the reference clock is not present at power-up, the outputs are forced to the center frequency of the crystal oscillator.

Reference CLK Monitor

The MAX9476 features internal clock (CLK) monitor circuitry to detect the presence of the external 8kHz reference clock. The internal CLK monitor continuously monitors the number of low-to-high transitions within a three-cycle (at 8kHz) time window. If the transition number is less than two, the internal CLK monitor states loss

of the reference CLK. However, if in a three-cycle time window the monitor counts two or three transitions, it considers the input reference clock as present. When the monitor detects the absence of the 8kHz reference clock, the outputs are operating at the center frequency of the crystal oscillator. However, when the monitor detects the return of the reference clock, the PLL locks to the reference clock. The ratio between the external crystal and the input reference clock is 4416.

Clock Outputs (CLK1 to CLK6) and REO

The MAX9476 uses a 35.328MHz crystal and a reference clock (REIN) to generate six identical outputs, CLK1 to CLK6, at 35.328MHz. All CLK_ outputs are LVTTL with a typical skew of 185ps. The MAX9476 also regenerates the 8kHz reference CLK at REO output.

Voltage-Controlled Crystal Oscillator (VCXO)

The MAX9476's internal VCXO takes an external 35.328MHz crystal as the base frequency and has a pulling range of approximately ±100ppm. This configuration also makes the VCXO PLL become a narrowband filter to reject high-frequency jitter on the input reference and eliminate it from the REO and CLK_ outputs.

$\overline{SHDN}$ Mode

The MAX9476 features a shutdown mode with a supply current of 7.5µA (typ). Drive $\overline{SHDN}$ low to get the device into shutdown mode. In this mode, all the outputs go low and the PLL is powered down. After $\overline{SHDN}$ goes high, the outputs still stay low for an additional 256ms to allow the PLL to be stabilized before the outputs are enabled again.

Applications Information

Crystal Selection

The MAX9476 uses a 35.328MHz crystal as the base frequency for the VCXO. It is important to use a correct type of quartz crystal to avoid reducing frequency pulling range, or excessive output phase jitter.

Choose an AT-cut crystal that oscillates at 35.328MHz on its fundamental mode with a variation of ±25ppm including frequency accuracy and operating temperature range. The crystal's load capacitance should be 14pF. Pulling range may vary depending on the crystal used. Refer to the MAX9476 evaluation kit for details.

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PLL Loop Filter

The PLL contains an integrated VCXO that uses an external crystal to track the input reference signal and attenuate input jitter. Figure 1 shows the external loop filter of the PLL containing resistor R1 and two capacitors, C1 and C2. This loop filter is connected between LP1 and LP2 as shown in the *Typical Operating Circuit*. The loop-filter bandwidth is determined by C1, C2, R1, and R_{SET} where R_{SET} is used to set the value of the charge-pump current. The typical values of C1, C2, R1, and R_{SET} are 22nF, 560pF, 1000kΩ, and 13kΩ, respectively.

Use the following equation to calculate a PLL loop bandwidth in Hz:

$$BW = (R1 \times I_{SETI} \times 1405) / N$$

where R1 (Ω) is the resistor in the PLL loop filter (Figure 1), I_{SETI} (A) is the charge-pump current calculated from the equation in the *Charge-Pump Current Setting* section, and N is the crystal PLL frequency divider equal to 4416.

The loop-damping factor is calculated by:

$$DampingFactor = \frac{R_1}{2} \times \sqrt{\frac{8832 \times I_{SETI} \times C_1}{N}}$$

where C1 (F) and R1 (Ω) are the values of the capacitor and the resistor in the PLL loop filter shown in Figure 1; I_{SETI} is calculated as shown in the *Charge-Pump Current Setting* section and N = 4416.

The following equation shows the relationship between components C1 and C2 in the loop filter:

$$C2 \leq C1 / 20$$

Charge-Pump Current Setting

The MAX9476 also allows external setting of the charge-pump current in the PLL. Connect a resistor from SETI to GNDP to set the PLL charge-pump current:

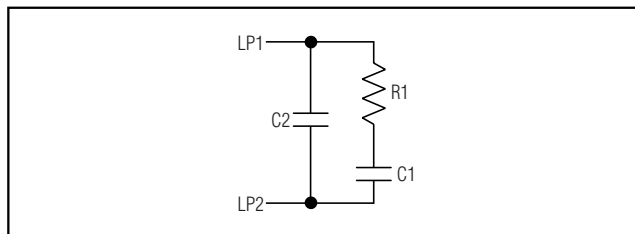$$\text{Charge-Pump Current} = 2.4 \times 1000 / (R_{SET}(k\Omega) + 1)$$

Figure 1. Typical Loop Filter

where R_{SET} is in kΩ and the value of the charge-pump current is in μA.

The loop response can be adjusted to meet individual application requirements since the charge-pump current and all the filter components for the VCXO loop can be set externally.

Board Layout and Bypassing

The MAX9476's high oscillator frequency makes proper layout important to ensure stability. For best performance, place components as close as possible to the device.

Digital or AC transient signals on GND can create noise at the clock outputs. Return GND to the highest quality ground available. Bypass V_{DD} and V_{DDP} with 0.1μF and 0.001μF capacitors, placed as close to the device as possible. Careful PC board ground layout minimizes crosstalk between the outputs and digital inputs.

Traces must be as short as possible on LP1 and LP2 and connect the capacitors and the resistor as close as possible to the device.

Chip Information

TRANSISTOR COUNT: 7512

PROCESS: CMOS

Low-Jitter, 8kHz Reference Clock Synthesizer Outputs 35.328MHz

Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.)

TSSOP4.40mm.EPS

TOP VIEW

BOTTOM VIEW

SIDE VIEW

END VIEW

SEE DETAIL A

SEATING PLANE

DETAIL A

PARTING LINE

0.25 BSC

WITH PLATING

BASE METAL

LEAD TIP DETAIL

SYMBOL	COMMON DIMENSIONS			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	—	1.10		.043
A$_1$	0.05	0.15	.002	.006
A$_2$	0.85	0.95	.033	.037
b	0.19	0.30	.007	.012
b$_1$	0.19	0.25	.007	.010
c	0.09	0.20	.004	.008
c$_1$	0.09	0.14	.004	.006
D	SEE VARIATIONS		SEE VARIATIONS	
E	4.30	4.50	.169	.177
e	0.65 BSC		.026 BSC	
H	6.25	6.55	.246	.258
L	0.50	0.70	.020	.028
N	SEE VARIATIONS		SEE VARIATIONS	
α	0°	8°	0°	8°

JEDEC			VARIATIONS			
MO-153	N		MILLIMETERS		INCHES	
			MIN.	MAX.	MIN.	MAX.
AB-1	14	D	4.90	5.10	.193	.201
AB	16	D	4.90	5.10	.193	.201
AC	20	D	6.40	6.60	.252	.260
AD	24	D	7.70	7.90	.303	.311
AE	28	D	9.60	9.80	.378	.386

NOTES:
1. DIMENSIONS D AND E DO NOT INCLUDE FLASH
2. MOLD FLASH OR PROTRUSIONS NOT TO EXCEED 0.15mm PER SIDE
3. CONTROLLING DIMENSION: MILLIMETER
4. MEETS JEDEC OUTLINE MO-153. SEE JEDEC VARIATIONS TABLE
5. 'N' REFERS TO NUMBER OF LEADS
6. THE LEAD TIPS MUST LIE WITHIN A SPECIFIED ZONE. THIS TOLERANCE ZONE IS DEFINED BY TWO PARALLEL PLANES. ONE PLANE IS THE SEATING PLANE, DATUM [-C-]; THE OTHER PLANE IS AT THE SPECIFIED DISTANCE FROM [-C-] IN THE DIRECTION INDICATED

DALLAS SEMICONDUCTOR **MAXIM**

PROPRIETARY INFORMATION

TITLE:
PACKAGE OUTLINE, TSSOP 4.40mm BODY

APPROVAL	DOCUMENT CONTROL NO.	REV.	
	21-0066	F	1/1